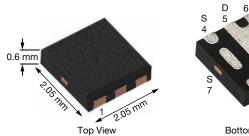
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Vishay Siliconix

N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY								
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A) ^{b, c}	Q _g (Typ.)					
20	0.0135 at V _{GS} = 10 V	12 ^a	5.3 nC					
	0.0185 at V _{GS} = 4.5 V	10.8	5.5110					

Thin PowerPAK[®] SC-70-6L Single



SiA430DJT-T1-GE3 (Lead (Pb)-free and halogen-free)

Marking Code: AY **Ordering Information:**



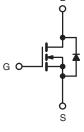
Bottom View

FEATURES

- TrenchFET[®] power MOSFET
- Thermally enhanced PowerPAK® SC-70 package - Small footprint area
 - Ultra-thin 0.6 mm height
- 100 % R_a tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Load switch
- DC/DC conversion



N-Channel MOSFET

D

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	20	Ň	
Gate-Source Voltage	V _{GS}	± 20	V		
	T _C = 25 °C		12 ^a		
	T _C = 70 °C		12 ^a		
Continuous Drain Current ($T_J = 150 \ ^\circ C$)	T _A = 25 °C	I _D	12 ^{a, b, c}		
	T _A = 70 °C		10.1 ^{b, c}	A	
Pulsed Drain Current (t = 100 µs)	I _{DM}	40			
Continuous Source Drain Diada Current	T _C = 25 °C	1	12 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.9 ^{b, c}		
	T _C = 25 °C		19.2		
Mauinum Dauss Disais atian	T _C = 70 °C		12.3	14/	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.5 ^{b, c}	W	
	T _A = 70 °C		2.2 ^{b, c}		
Operating Junction and Storage Temperatur	T _J , T _{stg}	-55 to +150	**		
Soldering Recommendations (Peak Tempera	ature) ^{d, e}		260	°C	

THEDMAL DEGISTANCE DATINGS

PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT					
Maximum Junction-to-Ambient b, f	t ≤ 5 s	R _{thJA}	28	36	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5	0/00				

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See solder profile (www.vishay.com/doc?73257). The Thin PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 80 °C/W.

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Document Number: 62991

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	20	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	24	-	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5.6	-	mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
Zara Cata Valtaga Drain Current	I	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20	-	-	А
		V _{GS} = 10 V, I _D = 7 A	-	0.0108	0.0135	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 5 A	-	0.0146	0.0185	Ω
Forward Transconductance a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}$	-	16	-	S
Dynamic ^b						
Input Capacitance	C _{iss}		-	800	-	pF
Output Capacitance	C _{oss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	-	200	-	
Reverse Transfer Capacitance	C _{rss}		-	90	-	
T + 10 + 0	Qg	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}$	-	12	18	
Total Gate Charge			-	5.3	9	
Gate-Source Charge Q _{gs}		$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 12 \text{ A}$	-	2	-	nC
Gate-Drain Charge	Q _{gd}		-	1.4	-	
Gate Resistance	R _g	f = 1 MHz	0.5	2.5	5	Ω
Turn-On Delay Time	t _{d(on)}		-	16	25	
Rise Time t		V_{DD} = 10 V, R _L = 1 Ω		10	15	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 10 A, V_GEN = 4.5 V, R_g = 1 Ω	-	15	25	- ns
Fall Time	t _f		-	10	15	
Turn-On Delay Time	t _{d(on)}		-	10	15	
Rise Time	t _r	V_{DD} = 10 V, R_L = 1 Ω	-	8	15	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	17	30	
Fall Time	t _f		-	8	15	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	Is	T _C = 25 °C	-	-	12	A
Pulse Diode Forward Current (t = 100 µs)	I _{SM}		-	-	40	
Body Diode Voltage	V _{SD}	I _S = 5 A, V _{GS} = 0 V	-	0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}		-	18	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	7	15	nC
Reverse Recovery Fall Time	ta	I _F = 10 A, di/dt = 100 A/μs, T _J = 25 °C	-	8	-	
Reverse Recovery Rise Time	t _b	1	-	10	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

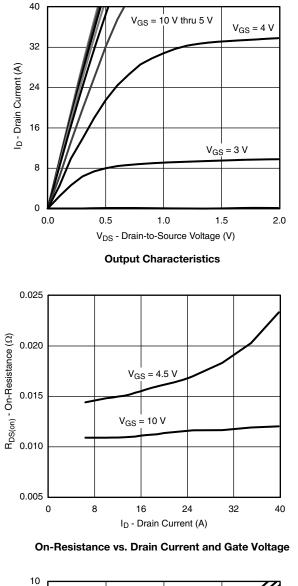
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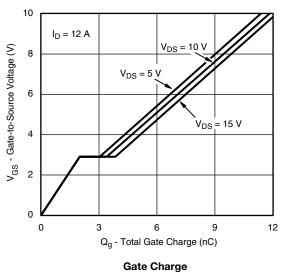
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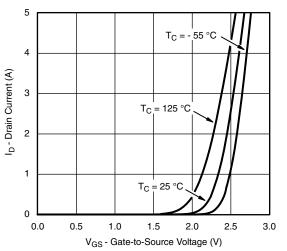
SiA430DJT

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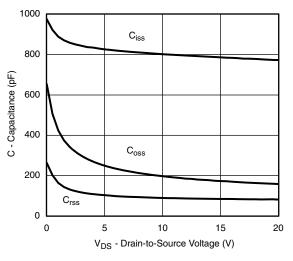
TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)



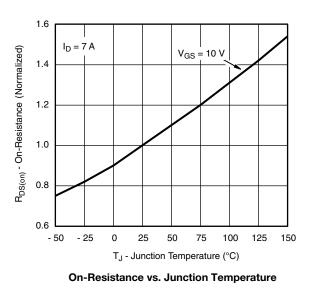




Transfer Characteristics







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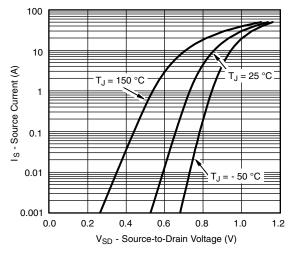
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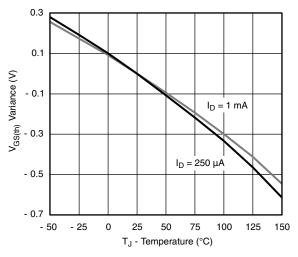
SiA430DJT

Vishay Siliconix

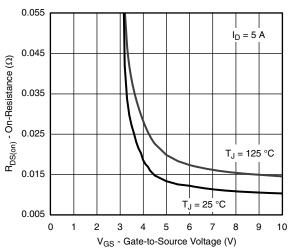
TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)



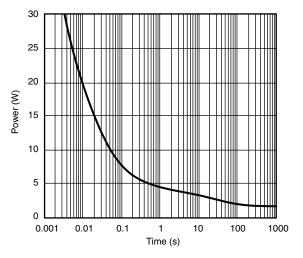
Source-Drain Diode Forward Voltage



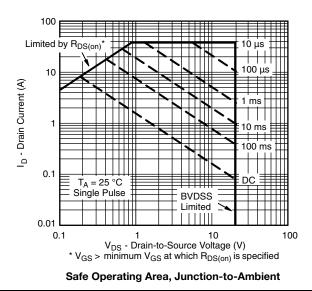




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



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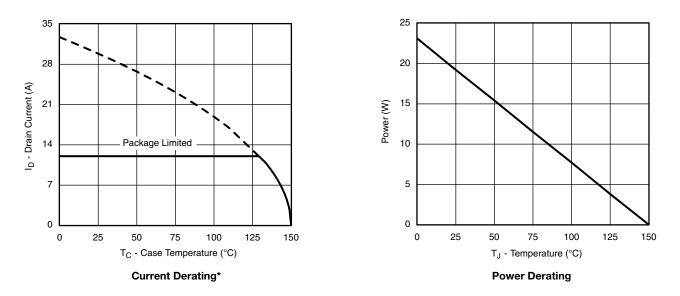
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TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)

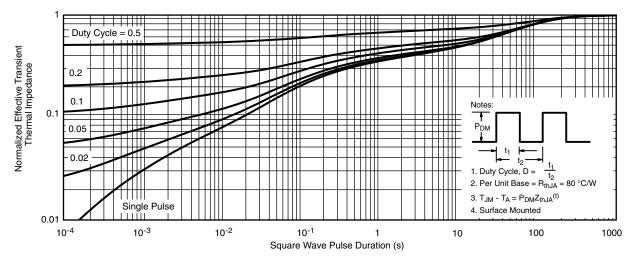


* The power dissipation P_D is based on T_{J (max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

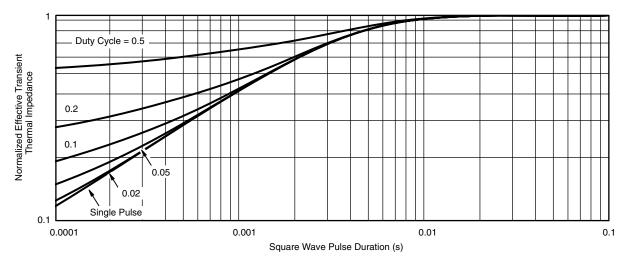


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TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

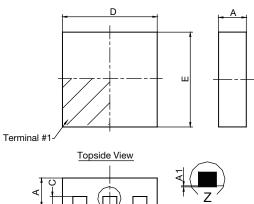
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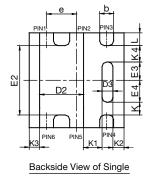
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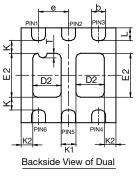
Case Outline for PowerPAK® SC70T



Side View







	SINGLE PAD					DUAL PAD						
DIM.	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.525	0.60	0.65	0.0206	0.024	0.026	0.525	0.60	0.65	0.0206	0.024	0.026
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D2	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D3	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E2	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E3	0.345	0.395	0.445	0.014	0.016	0.018						
E4	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC		0.65 BSC			0.026 BSC		
К		0.275 TYP.			0.011 TYP.		0.275 TYP.			0.011 TYP.		
K1		0.400 TYP.			0.016 TYP.		0.320 TYP.			0.013 TYP.		
K2		0.240 TYP.			0.009 TYP.		0.252 TYP.			0.010 TYP.		
K3		0.225 TYP.			0.009 TYP.							
K4		0.355 TYP.		0.014 TYP.								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
Т							0.05	0.10	0.15	0.002	0.004	0.006
ECN: C1 DWG: 59		v. B, 05-Ma	ar-12									

Notes

1. All dimensions are in millimeter. Millimeters will govern.

2. Package outline exculsive of mold flash and metal burr.

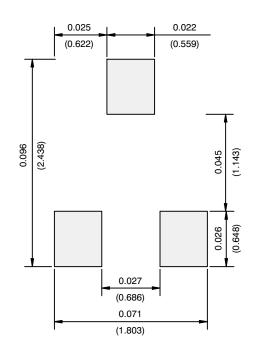
3. Package outline inclusive of plating



Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SC-70: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

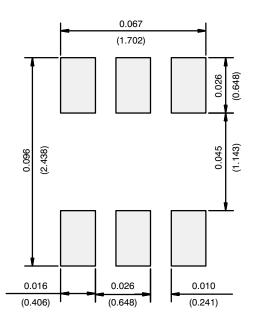
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Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SC-70: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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